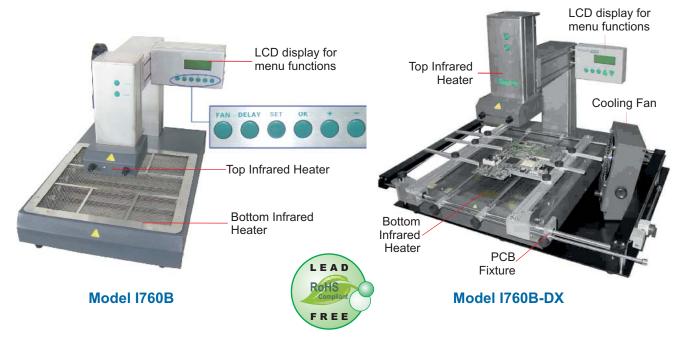


# Low Cost Effective BGA Rework System for service industry



## 1760B Scope of Supply

- I760B System with top/bottom IR Units
- User Manual
- Software
- RS232 & Power Cable

## 1760B-DX Scope of Supply

- I760B System with top/bottom IR Units
- PCB Holding and movement Fixture
- User Manual Cooling Fan
- Software
  RS232 & Power Cable

#### **Applications**

- Repair of laptops, mobiles
- Service Centers
- BGA Rework in Industries & Labs

#### **Unique Features**

- Focused Infrared heating delivers heat at the right place. No effect on adjacent components
- IR Pre-Heater 260x260 mm, 1500 W
- Programmable profiles: For precise rework process. (Pre-heating, Soak, Reflow and cooling stages)
- Closed-loop temperature control for precise temperatures
- PC based software: To monitor the process
- · Laser Pointer: for positioning component PCB
- PCB Holder: with smooth X-Y movement (for model I760-DX)
- · Can rework SMD, BGA, CSP, PGA, Sockets

### **Specifications**

 Power : 2200 Watt Voltage Range : 230 V, 50Hz

 Top IR Heater : 720 Watt, 60x60 mm size

 Top Heater Range : 20 ~ 60 mm

 Bottom Preheater : 1500 Watt (Infrared type)

 Bottom Preheater : 260x260 mm

· Heating time of : 10 sec (ambient ~ 230°C)

top preheater

 Communication : RS-232 for PC connection

: 0~300°C Infrared temp. sensor Outside K-type sensor : optional

 LCD Display : 16x2 character, 66x23.5 mm Dimensions(LxWxH) : 330x380x440 mm (approx.)

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